# **AN5650**

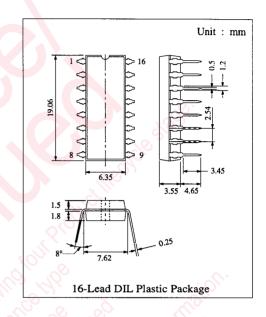
# Colour TV Synchronization Signal Processing Circuit

### ■ Description

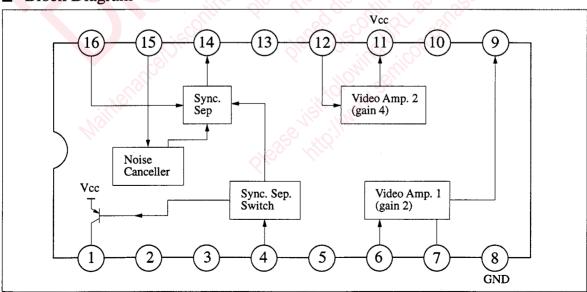
The AN5650 is an intergrated circuit designed for colour TV synchronizing signal processing circuit.

#### Features

- Built-in video signal amplifier circuit
- A synchronizing separation circuit highly stable against noise
- Built-in synchronization signal output switching circuit



### ■ Block Diagram



## ■ Absolute Maximum Ratings (Ta=25°C)

Item		Symbol	Ra	ing	Unit
	Supply Voltage	V <sub>13-8</sub>	14.4		V
Voltage		V <sub>1-8</sub>	0	V <sub>13-8</sub>	V
	Circuit Voltage	V <sub>4-8</sub>	0	V <sub>13-8</sub>	V
		V <sub>6-8</sub>	0	V <sub>13-8</sub>	V
		V <sub>7-8</sub>	0	V <sub>13-8</sub>	V
		V <sub>12-8</sub>	0	V <sub>13-8</sub>	V
		V <sub>14-8</sub>	0	V <sub>13-8</sub>	V
		V <sub>15-8</sub>	0	6	V
		V <sub>16-8</sub>	-3	2	V
Current	Supply Current	I <sub>13</sub>	40		mA
	****	$I_1$	-2	0	mA
	Circuit Current	I <sub>7</sub>	-3	0	mA
		I <sub>9</sub>	-5	0	mA
		I <sub>11</sub>	-5	0 0	mA
		I <sub>14</sub>	0	10	mA
		I <sub>16</sub>	-1	103	mA
Power Dissipation		$P_{D}$	560		mW
Operating Ambient Temperature		Topr	-20 ~ +70°C		°C
torage Temperature		Tstg	-55 ~ +	-150°C	°C

# ■ Electrical Characteristics (Ta=25°C)

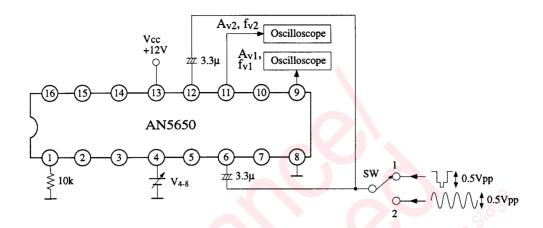
Item	Symbol	Test Cct	Condition	min.	typ.	max.	Unit
Voltage Gain (Video Amp. 1)	A <sub>v1</sub>	1	Video signal input 0.5Vpp SW1	1.5	1.9	2.3	times
Voltage Gain (Video Amp. 2)	A <sub>v2</sub>	1	Video signal input 0.5Vpp SW2	3.4	3.9	4.3	times
Frequency Characteristics (Video Amp. 1)	fvl	1	Sine wave input 0.5Vpp SW2 input frequency when A <sub>V1</sub> becomes -3dB	5	0.	3,	MHz
Frequency Characteristics (Video Amp. 2)	fv2	10	Sine wave input 0.5Vpp SW2 input frequency when A <sub>V2</sub> becomes -3dB	5	5.		MHz
Switch Operating Voltage	V4-8	1	Switch input voltage when switch output becomes 0.7V or more	1.5			v
Max. Allowable Input (Video Amp. 1)	Vin(max.)1	1	APL = 50%			1.9	Vpp
Max. Allowable Input (Video Amp. 2)	Vin(max.)2	1	APL = 50%			1.4	Vpp
Sync. Sep. Input*	Vin3	2	Vcc = 12V, APL = 50%	1.0		2.5	Vpp

<sup>\*</sup> Design reference value

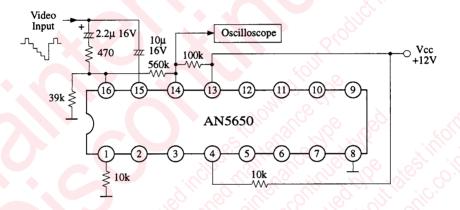
## ■ Pin Description

Pin No	Pin Name	0/6,0	Pin No	Pin Name
1	Switch Output		9	Video Signal Output 1
2	NC 10		10	NC
3	NC		11	Video Signal Output 2
4	Sync. Sep. Switch Input		12	Video Signal Input 2
5	NC		13	Vcc
6	Video Signal Input 1		14	Sync. Sep. Output
7	Gain Control		15	Noise Det. Input
8	GND		16	Video Signal Input 3

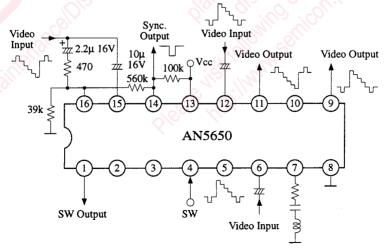
Test Circuit 1 (Av1, Av2, fv1, fv2, V4-8, Vin(max.)1, Vin(max.)2)



#### Test Circuit 2 (Vin3)



## Application Circuit



(When input is high, Sync. Sep. and SW Output Operates.)

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